

Datasheet revision 1.0 www.chipquik.com

# ROL0 No-Clean Tack Flux in a 3cc/3g Luer Lock Manual Syringe w/tips

## **Product Highlights**

More Robust, Higher Activity, Better Wetting, No-Clean

Ideal for all rework, solder, de-solder and reflow applications

Non-corrosive, non-conductive

Tack flux will not run all over PCB when applied

Has a pleasant odor

**Excellent wetting** 

Easily cleaned with isopropyl alcohol (IPA)

Attachment of BGA spheres

Soldering flip chip components

Long stencil life

Wide process window

Clear residue

Can be used with Leaded and Lead-Free applications

**RoHS 3 and REACH compliant** 



### **Specifications**

Flux Type: Synthetic No-Clean (for Leaded and Lead-Free applications)

Flux Classification: ROL0

Flux Activation Temperature: 140°C (284°F)

Packaging: 3cc/3g Luer Lock Manual Syringe w/tips

Shelf Life: Refrigerated >24 months, Unrefrigerated >24 months

#### **Stencil Life**

>8 hours @ 20-50% RH 22-28°C (72-82°F) >4 hours @ 50-70% RH 22-28°C (72-82°F)

### **Stencil Cleaning**

Automated stencil cleaning systems for both stencil and misprinted boards. Manual cleaning using isopropyl alcohol (IPA).

#### Storage and Handling

Store refrigerated or at room temperature 3-25°C (37-77°F). Do not freeze. Allow 4 hours for flux to reach an operating temperature of 20-25°C (68-77°F) before use.

#### **Transportation**

This product has no shipping restrictions. Shipping below 0°C (32°F) or above 25°C (77°F) for normal transit times by ground or air will not impact this product's stated shelf life.

#### **Conforms to the following Industry Standards:**

J-STD-004B. Amendment 1 (Solder Fluxes):

RoHS 3 Directive (EU) 2015/863:

Yes

Yes